

**RECEIVED  
CENTRAL FAX CENTER****JUL 31 2005**Customer No.: 31561  
Application No.: 10/711,575  
Docket No.: 10792-US-PA


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In re application of:		)
Application No.:	10/711,575	)
Filed:	September 25, 2004	)
For:	STACKED CHIP-PACKAGING STRUCTURE	)
		)
Applicant	Tsai et al.	)
Examiner:	Gebremariam, Samuel A.	)
Art Unit:	2811	)

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**AUTHORIZATION TO COMMUNICATIONS VIA THE INTERNET  
UNDER (ARTICLE 5)**

Recognizing that Internet communications are not secure, I, the power of attorney of record, hereby authorize the USPTO to communicate with me concerning with the Office Action of this application by electronic mail. I understand that a copy of these communications will be made of record in the application file.

Date: *July 19, 2005*  
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